

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT														
NATURE OF CONVEYANCE:	ASSIGNMENT														
CONVEYING PARTY DATA															
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>Rabindra N. Das</td> <td>05/05/2011</td> </tr> <tr> <td>Voya R. Markovich</td> <td>05/12/2011</td> </tr> <tr> <td>John M. Lauffer</td> <td>05/09/2011</td> </tr> <tr> <td>Roy H. Magnuson</td> <td>05/06/2011</td> </tr> <tr> <td>Konstantinos I. Papathomas</td> <td>05/12/2011</td> </tr> <tr> <td>Benson Chan</td> <td>05/05/2011</td> </tr> </tbody> </table>		Name	Execution Date	Rabindra N. Das	05/05/2011	Voya R. Markovich	05/12/2011	John M. Lauffer	05/09/2011	Roy H. Magnuson	05/06/2011	Konstantinos I. Papathomas	05/12/2011	Benson Chan	05/05/2011
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CORRESPONDENCE DATA															
Fax Number: (607)723-6605 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i> Phone: 6072316991 Email: amanzner@hhk.com Correspondent Name: Mark Levy HINMAN, HOWARD & KATTELL, LLP Address Line 1: 80 Exchange Street Address Line 2: P.O. Box 5250 Address Line 4: BINGHAMTON, NEW YORK 13901															
ATTORNEY DOCKET NUMBER:	EI-2-06-029														

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PATENT
REEL: 026705 FRAME: 0609

NAME OF SUBMITTER:

Mark Levy, Registration No. 29188

Total Attachments: 2

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Assignment of Rights, Title and Interest in Invention
(Multiple inventors; single assignee)

Docket No.
EI-2-06-029

This is an Assignment of the following rights, title and interest: (check all that apply):

- ☒ *United States of America rights, title and interest in the invention*
☒ *Foreign rights, title and interest in the invention*
☐ *United States Patent Application Serial No. _____*

Date of Execution: _____

Date of Filing: _____

- ☐ *United States Provisional Patent Application Serial No. _____*
☐ *United States Patent No(s). _____*
☐ *International (PCT) Patent Application Serial No. _____*
☐ *Other (specify) _____*

Title of the Invention

ELECTRICALLY CONDUCTIVE ADHESIVE (ECA) FOR MULTILAYER DEVICE INTERCONNECTS

Inventors (assignors)

<i>Name</i>	<i>Address</i>
Rabindra N. Das	3113 Belmont Avenue, Vestal, NY 13850
Voya R. Markovich	3611 Joel Drive, Endwell, NY 13760
John M. Lauffer	213 Lincoln Street Extension, Waverly, NY 14892
Roy H. Magnuson	804 Audrey Court, Endicott, NY 13760
Konstantinos I. Papathomas	75 Coventry Road, Endicott, NY 13760
Benson Chan	117 Carol Avenue, Vestal, NY 13850

Assignee

<i>Name</i>	<i>Address</i>
Endicott Interconnect Technologies, Inc.	1093 Clark Street Endicott, NY 13760

Assignment of Rights, Title and Interest in Invention
(Multiple inventors; single assignee)

Docket No.
E1-2-06-029

Whereas, we, the above-identified Inventors, have invented certain new and useful improvements in the Invention identified above and described in the above-identified patent application(s) and/or patent(s) (hereinafter referred to as "Invention");

And, whereas we desire to assign our above-identified rights, title and interest in the Invention to the above-identified Assignee;

Now, this indenture witnesseth, that for good and valuable consideration, the receipt whereof is hereby acknowledged;

We hereby assign, sell and transfer our above-identified rights, title and interest in said Invention, said application(s) as identified above, including any divisions, continuations, and continuations-in-part thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted or have granted for said Invention, and in and to any and all reissues and reexaminations thereof, and in and to any and all priority rights, Convention rights, and other benefits accruing or to accrue to us with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, unto said Assignee;

And we hereby authorize and request the Director of the United States Patent and Trademark Office to issue any United States Letters Patent which may issue for said Invention to said Assignee, as assignee of the whole right, title and interest thereto;

And we further agree to sign and execute all necessary and lawful future documents, including applications for foreign patents, for filing divisions, continuations and continuations-in-part of said application for patent, and/or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid Invention, as the Assignee or its Designee(s) may from time to time require and prepare at its own expense.

Inventors' Signatures (if Notarization is desired, do not sign here and proceed to next page)

Name	Signature/Date
Rabindra N. Das	Rabindra N. Das 5/5/2011
Voya R. Markovich	Voya R. Markovich 5/12/2011
John M. Lauffer	John M. Lauffer 5/9/2011
Roy H. Magnuson	Roy H. Magnuson 5/12/2011
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